

AMPMODU | Modu Connector System

TE Internal #: 535512-4

Modu Connector System, PCB Mount Receptacle, Right Angle, Board-to-Board, 34 Position, 2.54mm [.1in] Centerline, Gold,

Printed Circuit Board

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Right Angle
Connector System: Board-to-Board

Number of Positions: 34

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

Applied Pressure	High, Standard
PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Rows	2
Stackable	Yes
PCB Mount Orientation	Right Angle
Number of Positions	34

Electrical Characteristics

Dielectric Withstanding Voltage (Max)	750 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	333 VAC

Body Features

Contact Features

Contact Protection Type	Closed Entry Housing



Contact Mating Area Length	3 mm[.1 in]
Mating Square Post Dimension	.64 mm[.025 in]
	10 μin
Contact Shape & Form	Short Point
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	2.92 mm[.115 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Side
Centerline (Pitch)	2.54 mm[.1 in]
Housing Color	Black
Housing Material	Polyester - GF
Dimensions	
Connector Height	6.05 mm[.238 in]
Row-to-Row Spacing	2.54 mm, 7.87 mm[.31 in]
Stack Height	8.13 mm[.32 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]
Usage Conditions	
Housing Temperature Rating	High



Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	13
Packaging Method	Box & Tube, Tube
Other	
Comment	6.50 [.256] minimum positive pin stop to prevent shorting between rows., TE recommends mating gold or duplex plated headers with duplex plated receptacle

assemblies.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2019 (197) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

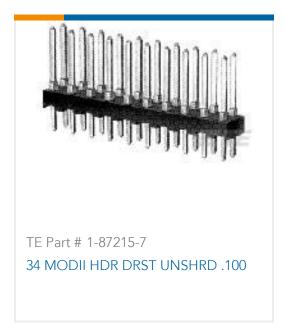
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part



numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | Modu Connector System







Board-to-Board Headers & Receptacles(1243)

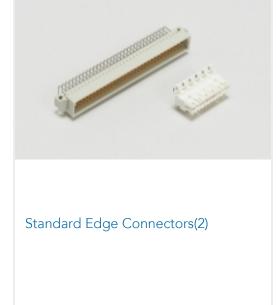


Board-to-Board Jumpers & Shunts(5)



PCB Connector Covers(4)





Customers Also Bought











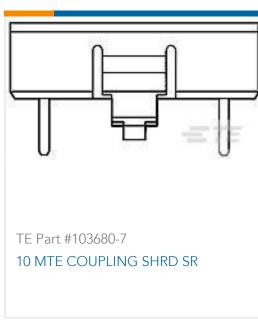






TE Part #1635014002 Single Wall RT 555: Heat Shrink Tubing, 2:1 Shrink Ratio







Documents

Product Drawings

34 MODII HORZ DR CE

English

CAD Files

Customer View Model

ENG_CVM_535512-4_Y1.3d_igs.zip

English

Customer View Model

ENG_CVM_535512-4_Y1.2d_dxf.zip

English

Customer View Model

ENG_CVM_535512-4_Y1.3d_stp.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English